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### 1W, 2010, Low Resistance Chip Resistor (Lead / Halogen Free)

### 1. Scope

This specification applies to 5.0mm x 2.5mm size 1W, fixed thick film low resistance value chip resistors rectangular type.

### 2. Type Designation

SCRR	2010	S	1	-		
(1)	(2)	(3)	(4)		(5)	(6)

Where

- (1) Series No.
- (2) Size
- (3) Terminal Type

S= Short terminal type

(4) Power Rating:

1 = 1W

(5) Resistance value:

For example --

 $R075 = 0.075\Omega$ 

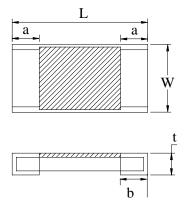
 $R100 = 0.1\Omega$ 

The "R" shall be used as a decimal point

(6) Tolerance (%)

$$F=\pm 1\%$$
,  $G=\pm 2\%$ ,  $J=\pm 5\%$ 

### 3. Outline Dimensions



Code Letter	Dimension
L	5.00± 0.15
W	$2.50 \pm 0.15$
t	$0.55 \pm 0.15$
a	$0.60 \pm 0.20$
b	$1.10 \pm 0.20$

Unit: mm

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4. Ratings

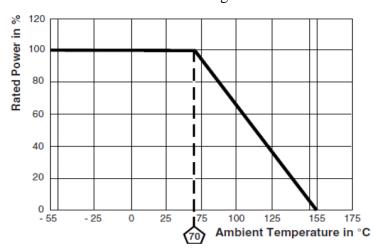
4-1 Specification

Table 1

Power Rating*	1 W		
Resistance Tolerance	1%(F), 2%(G), 5%(J)		
Resistance Range	$0.05\Omega \sim <0.45\Omega$	$0.45\Omega \sim 1\Omega$	
Temperature Coefficient of Resistance(ppm/°C)	0~+200	0 ~ +75	

### Note\*:

Power Rating is based on continuous full load operation at rated ambient temperature of  $70^{\circ}$ C. For resistor operated at ambient temperature in excess of  $70^{\circ}$ C, the maximum load shall be derated in accordance with the following curve.



### 4-2 Rated Voltage

The d.c. or a.c. r.m.s. voltage shall be calculated from the following expression

 $V = \sqrt{P \times R}$ 

Where V : Rated voltage (V)

P : Rated power (W)

R : Nominal resistance  $(\Omega)$ 

### 4-3 Operating and Storage Temperature Range

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### 5. Marking

Each Resistor is marked with 4 digits code on the protective coating to designate to the nominal resistance value.

$$0.05 \le R \le 1\Omega$$
, Marking 4 digits   
EX)  $0.05\Omega \rightarrow \boxed{R050}$   
 $1.0\Omega \rightarrow \boxed{1R00}$ 

### 6. Characteristics

### 6-1 Electrical

Item	Specification and Requirement	Test Method (JIS 5201)
Temperature Coefficient of Resistance (TCR)		Room temperature Room temperature+100°C
Short Time Overload	ΔR:±1.0% Without damage by flashover, spark, arcing, burning or breakdown	<ul><li>(1) Applied voltage: 2.5 x rated voltage</li><li>(2) Test time: 5 seconds</li></ul>
Insulation Resistance	Over $100  \text{M}\Omega$ on Overcoat layer face up Over $1{,}000  \text{M}\Omega$ on Substrate side face up	<ol> <li>Setup as figure 1</li> <li>Test voltage: 100V<sub>DC</sub>±15V<sub>DC</sub></li> <li>Test time: 60 + 10 / - 0 seconds</li> </ol>
Voltage Proof	Resistance range:±1.0% Without damage by flashover, spark, arcing, burning or breakdown	<ol> <li>Setup as figure 1</li> <li>Test voltage: 400V<sub>AC</sub>(rms.)</li> <li>Test time: 60 + 10 / - 0 seconds</li> </ol>

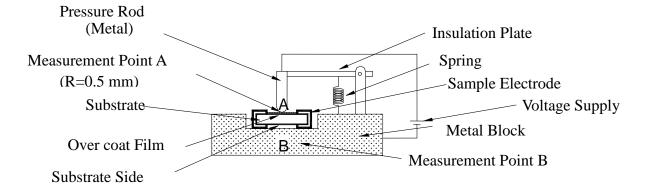


Figure 1 : Measurment Setup

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### 6-2 Mechanical

Item	Specification and Requirement	Test Method (JIS 5201)
Solderability	The surface of terminal immersed shall be minimum of 95% covered with a new coating of solder	Solder bath: After immersing in flux, dip in 245 ± 5°C molten solder bath for 2 ± 0.5 seconds
Resistance to Solder Heat	△ R: ± 1.0% Without distinct deformation in appearance	<ul> <li>(1) Pre-heat: 100~110°C for 30 seconds</li> <li>(2) Immersed at solder bath of 270 ± 5°C for 10 ± 1 seconds</li> <li>(3) Measuring resistance 1 hour after test</li> </ul>
Bending Test	△ R: ± 1.0% Without mechanical damage such as break	Bending value: 1 mm for 30 ± 1 seconds
Solvent Resistance	Without mechanical and distinct damage in appearance	<ul><li>(1) Solvent: Trichloroethane or Isopropyl alcohol</li><li>(2) Immersed in solvent at room temperature for 300 seconds</li></ul>

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6-3 Enduranc	e
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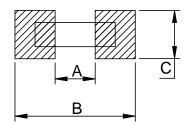
Item	Specification and Requirement	Test Method (JIS 5201)
Rapid Change of Temperature	△ R:±1.0% Without distinct damage in appearance	<ul> <li>(1) -55°C to +150°C, 1000 cycles, 15min at each extreme</li> <li>(2) Measuring resistance 1 hour after test</li> </ul>
Moisture with Load	△ R: ±5.0% Without distinct damage in appearance	<ul> <li>(1) Environment condition: 60 ± 2°C,90~95% RH</li> <li>(2) Applied Voltage: rated voltage</li> <li>(3) Test period: (1.5 hour ON) →(0.5 hour OFF) cycled for total 1,000 + 48 / - 0 hours</li> <li>(4) Measuring resistance 1 hour after test</li> </ul>
Load Life	△ R: ±5.0% Without distinct damage in appearance	<ul> <li>(1) Test temperature: 70 ± 3°C</li> <li>(2) Applied Voltage: rated voltage</li> <li>(3) Test period: (1.5 hour ON)  →(0.5 hour OFF) cycled for total  1,000 + 48 / - 0 hours</li> <li>(4) Measuring resistance  1 hour after test</li> </ul>
Low Temperature Store	△ R: ± 5.0% Without distinct damage in appearance	<ul> <li>(1) Store temperature: -55 ± 3°C for total 1,000 + 48 / - 0 hours</li> <li>(2) Measuring resistance 1 hour after test</li> </ul>
High Temperature Store	△ R: ± 5.0% Without distinct damage in appearance	<ul> <li>(1) Store temperature: +155 ± 3°C for total 1,000 + 48 / - 0 hours</li> <li>(2) Measuring resistance 1 hour after test</li> </ul>

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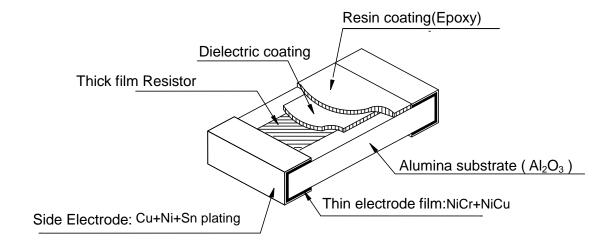
### 7. Recommend Land Pattern Dimensions



A	2.5~2.7
В	6.1~6.3
C	2.6~2.8

Unit: mm

### 8. Construction Drawing



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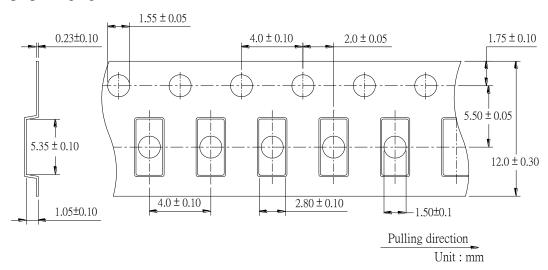
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### 9. Packaging

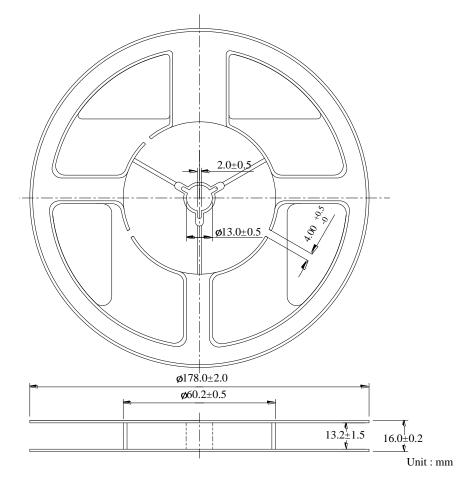
### 9-1 Dimensions

### 9-1-1 Tape packaging dimensions



Remark: Leader tape length ≥ 30 cm( 150 Hollow carrier cavity)

### 9-1-2 Reel dimensions



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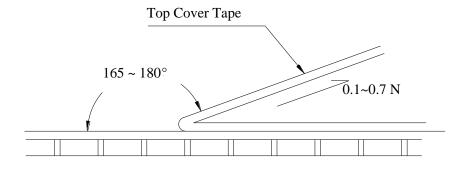
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### 9-2 Peel force of top cover tape

The peel speed shall be about 300 mm/min.

The peel force of top cover tape shall be between 0.1 to 0.7 N.



- 9-3 Numbers of taping 2,000 pieces /reel
- 9-4 Label making

The following items shall be marked on the reel.

- (1) Type designation.
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name

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#### 10. Carenote

### 10-1 Care note for storage

(1) Chip resistor shall be stored in a room where temperature and humidity must be controlled. (temperature 5 to 35°C, humidity 45 to 85% RH) However, a humidity keep it low, as it is possible.

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- (2) Chip resistor shall be stored as direct sunshine doesn't hit on it.
- (3) Chip resistor shall be stored with no moisture, dust, a material that will make solderability inferior, and a harmful gas (Chloridation hydrogen, sulfurous acid gas, and sulfuration hydrogen)

### 10-2 Carenote for operating and handling

- (1) It is necessary to protect the edge and protection coat of resistors from mechanical stress.
- (2) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (3) Resistors shall be used with in rated range shown in specification. Especially, if voltage more than specified value will be loaded to resistor, there is a case it will make damage for machine because of temperature rise depending on generating of heat, and increase resistance value or breaks.
- (4) In case that resistor is loaded a rated voltage, it is necessary to confirms temperature of a resistor and to reduce a load power according to load reduction curve, because a temperature rise of a resistor depends on influence of heat from mounting density and neighboring element.
- (5) Observe Limiting element voltage and maximum overload voltage specified in each specification
- (6) If there is possibility that a large voltage (pulse voltage, shock voltage) charge to resistor, it is necessary that operating condition shall be set up before use.